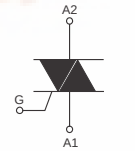
BTA/BTB12 and T12 Series

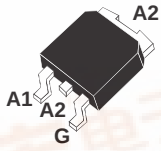
SNUBBERLESS™, LOGIC LEVEL & STANDARD

12A TRIACs

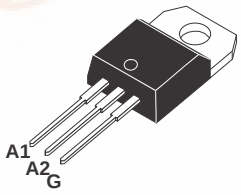
MAIN FEATURES:

Symbol	Value	Unit
$I_{T(RMS)}$	12	A
V_{DRM}/V_{RRM}	600 and 800	V
$I_{GT\ (Q_1)}$	5 to 50	mA

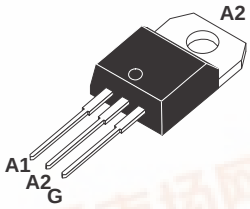




D^2PAK
(T12-G)



TO-220AB Insulated
(BTA12)



TO-220AB
(BTB12)

DESCRIPTION

Available either in through-hole or surface-mount packages, the BTA/BTB12 and T12 triac series is suitable for general purpose AC switching. They can be used as an ON/OFF function in applications such as static relays, heating regulation, induction motor starting circuits... or for phase control operation in light dimmers, motor speed controllers,...

The snubberless versions (BTA/BTB...W and T12 series) are specially recommended for use on inductive loads, thanks to their high commutation performances. Logic level versions are designed to interface directly with low power drivers such as microcontrollers. By using an internal ceramic pad, the BTA series provides voltage insulated tab (rated at 2500V RMS) complying with UL standards (File ref.: E81734)

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter			Value	Unit
$I_{T(RMS)}$	RMS on-state current (full sine wave)	D^2PAK/TO-220AB	Tc = 105°C	12	A
		TO-220AB Ins.	Tc = 90°C		
I_{TSM}	Non repetitive surge peak on-state current (full cycle, Tj initial = 25°C)	F = 50 Hz	t = 20 ms	120	A
		F = 60 Hz	t = 16.7 ms	126	
I^2t	I^2t Value for fusing	tp = 10 ms		78	A^2s
dI/dt	Critical rate of rise of on-state current I_G = 2 x I_{GT} , tr ≤ 100 ns	F = 120 Hz	Tj = 125°C	50	A/µs
V_{DSM}/V_{RSM}	Non repetitive surge peak off-state voltage	tp = 10 ms	Tj = 25°C	V_{DRM}/V_{RRM} + 100	V
I_{GM}	Peak gate current	tp = 20 µs	Tj = 125°C	4	A
$P_{G(AV)}$	Average gate power dissipation		Tj = 125°C	1	W
T_{stg} T_j	Storage junction temperature range Operating junction temperature range			- 40 to + 150 - 40 to + 125	°C

ELECTRICAL CHARACTERISTICS (Tj = 25°C, unless otherwise specified)

■ **SNUBBERLESS™ and LOGIC LEVEL (3 Quadrants)**

Symbol	Test Conditions	Quadrant		T12		BTA/BTB12			Unit
				T1235	TW	SW	CW	BW	
I_{GT} (1)	V_D = 12 V R_L = 30 Ω	I - II - III	MAX.	35	5	10	35	50	mA
V_{GT}		I - II - III	MAX.	1.3					V
V_{GD}	$V_D = V_{DRM}$ R_L = 3.3 kΩ Tj = 125°C	I - II - III	MIN.	0.2					V
I_H (2)	I_T = 100 mA		MAX.	35	10	15	35	50	mA
I_L	$I_G = 1.2\ I_{GT}$	I - III	MAX.	50	10	25	50	70	mA
		II		60	15	30	60	80	
dV/dt (2)	V_D = 67 %V_{DRM} gate open Tj = 125°C		MIN.	500	20	40	500	1000	V/µs
(dI/dt)c (2)	(dV/dt)c = 0.1 V/µs Tj = 125°C		MIN.	-	3.5	6.5	-	-	A/ms
	(dV/dt)c = 10 V/µs Tj = 125°C			-	1	2.9	-	-	
	Without snubber Tj = 125°C			6.5	-	-	6.5	12	

■ **STANDARD (4 Quadrants)**

Symbol	Test Conditions	Quadrant		BTA/BTB12		Unit
				C	B	
I_{GT} (1)	V_D = 12 V R_L = 30 Ω	I - II - III IV	MAX.	25 50	50 100	mA
V_{GT}		ALL	MAX.	1.3		V
V_{GD}	$V_D = V_{DRM}$ R_L = 3.3 kΩ Tj = 125°C	ALL	MIN.	0.2		V
I_H (2)	I_T = 500 mA		MAX.	25	50	mA
I_L	$I_G = 1.2\ I_{GT}$	I - III - IV	MAX.	40	50	mA
		II		80	100	
dV/dt (2)	V_D = 67 %V_{DRM} gate open Tj = 125°C		MIN.	200	400	V/µs
(dV/dt)c (2)	(dI/dt)c = 5.3 A/ms Tj = 125°C		MIN.	5	10	V/µs

STATIC CHARACTERISTICS

Symbol	Test Conditions			Value	Unit
V_T (2)	I_{TM} = 17 A tp = 380 µs	Tj = 25°C	MAX.	1.55	V
V_{to} (2)	Threshold voltage	Tj = 125°C	MAX.	0.85	V
R_d (2)	Dynamic resistance	Tj = 125°C	MAX.	35	mΩ
I_{DRM}	$V_{DRM} = V_{RRM}$	Tj = 25°C	MAX.	5	µA
I_{RRM}		Tj = 125°C		1	mA

Note 1: minimum IGT is guaranted at 5% of IGT max.

Note 2: for both polarities of A2 referenced to A1

THERMAL RESISTANCES

Symbol	Parameter			Value	Unit
$R_{th(j-c)}$	Junction to case (AC)		D^2PAK/TO-220AB	1.4	°C/W
			TO-220AB Insulated	2.3	
$R_{th(j-a)}$	Junction to ambient	S = 1 cm^2	D^2PAK	45	°C/W
			TO-220AB TO-220AB Insulated	60	

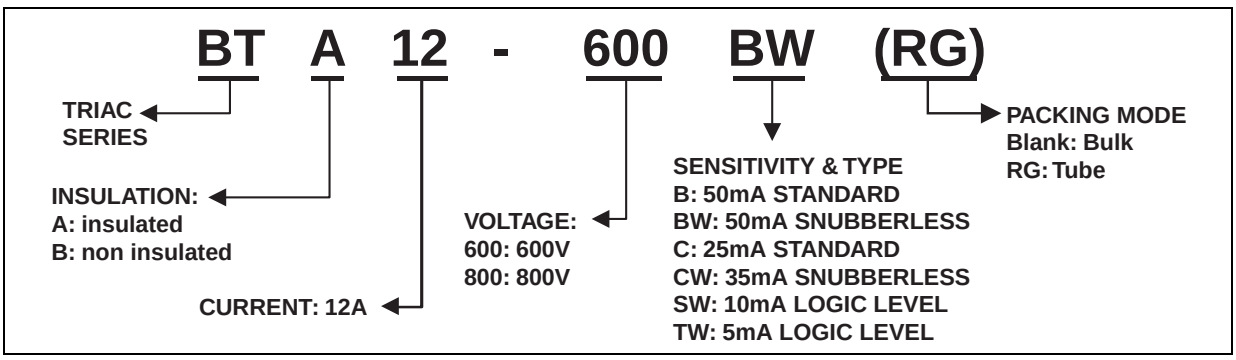
S = Copper surface under tab

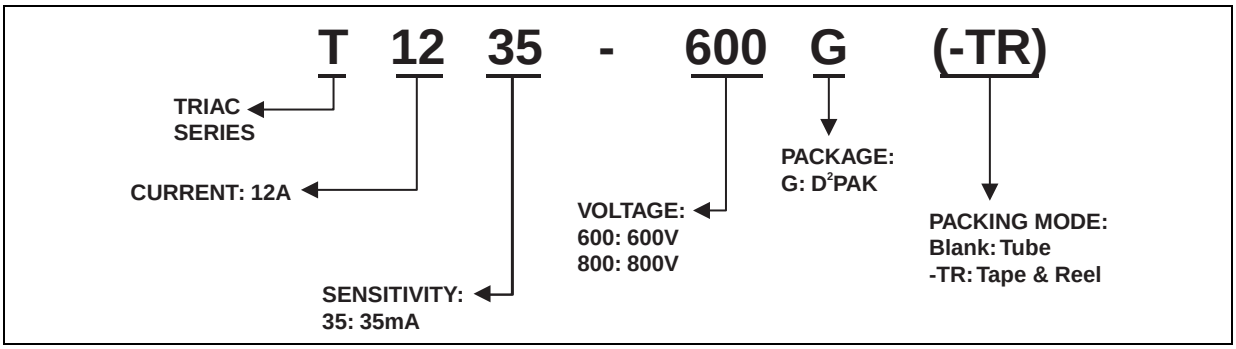
PRODUCT SELECTOR

Part Number	Voltage (xxx)		Sensitivity	Type	Package
	600 V	800 V			
BTA/BTB12-xxxB	X	X	50 mA	Standard	TO-220AB
BTA/BTB12-xxxBW	X	X	50 mA	Snubberless	TO-220AB
BTA/BTB12-xxxC	X	X	25 mA	Standard	TO-220AB
BTA/BTB12-xxxCW	X	X	35 mA	Snubberless	TO-220AB
BTA/BTB12-xxxSW	X	X	10 mA	Logic level	TO-220AB
BTA/BTB12-xxxTW	X	X	5 mA	Logic Level	TO-220AB
T1235-xxxG	X	X	35 mA	Snubberless	D^2PAK

BTB: non insulated TO-220AB package

ORDERING INFORMATION





OTHER INFORMATION

Part Number	Marking	Weight	Base quantity	Packing mode
BTA/BTB12-xxxyz	BTA/BTB12-xxxyz	2.3 g	250	Bulk
BTA/BTB12-xxxyzRG	BTA/BTB12-xxxyz	2.3 g	50	Tube
T1235-xxxG	T1235xxxG	1.5 g	50	Tube
T1235-xxxG-TR	T1235xxxG	1.5 g	1000	Tape & reel

Note: xxx = voltage, yy = sensitivity, z = type

Fig. 1: Maximum power dissipation versus RMS on-state current (full cycle).

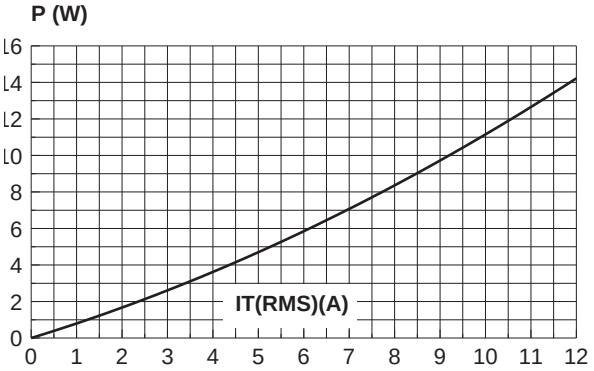


Fig. 2-1: RMS on-state current versus case temperature (full cycle).

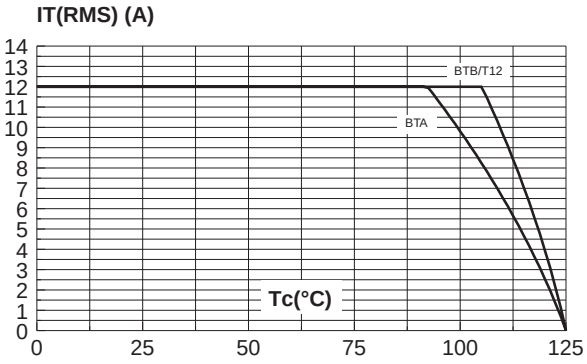


Fig. 2-2: RMS on-state current versus ambient temperature (printed circuit board FR4, copper thickness: 35µm),full cycle.

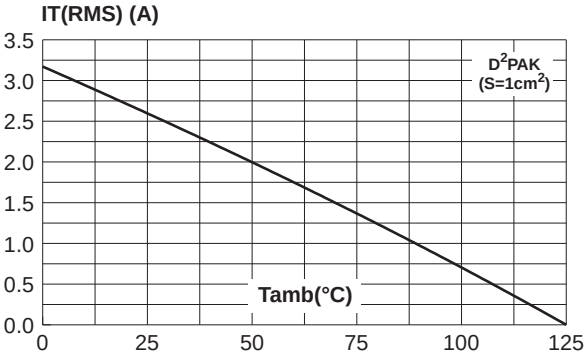


Fig. 3: Relative variation of thermal impedance versus pulse duration.

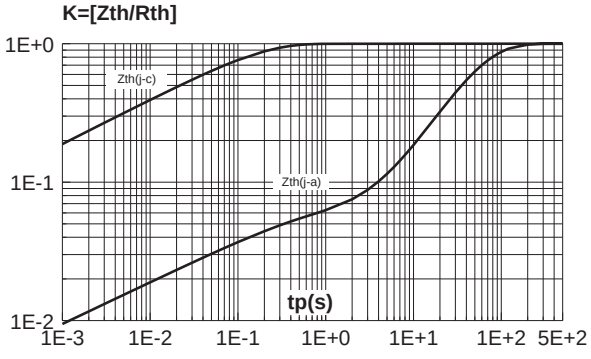


Fig. 4: On-state characteristics (maximum values).

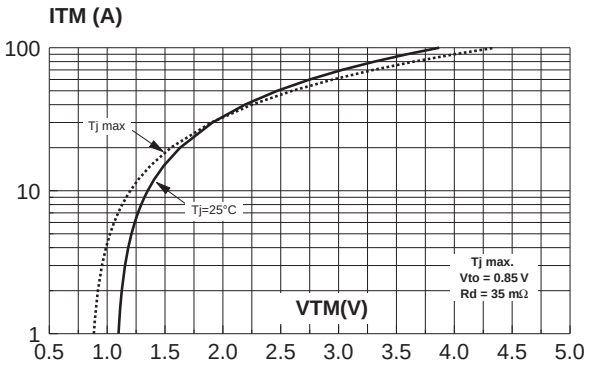


Fig. 5: Surge peak on-state current versus number of cycles.

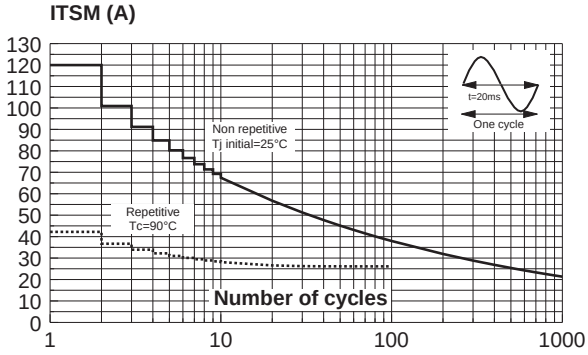


Fig. 6: Non-repetitive surge peak on-state current for a sinusoidal pulse with width tp < 10ms, and corresponding value of I²t.

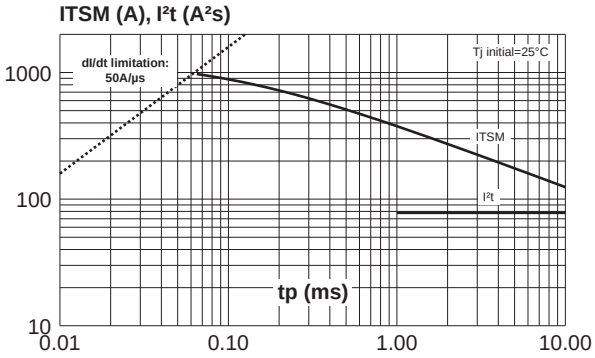


Fig. 7: Relative variation of gate trigger current, holding current and latching current versus junction temperature (typical values).

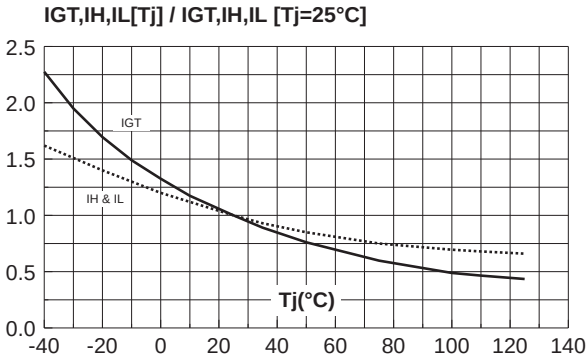


Fig. 8-1: Relative variation of critical rate of decrease of main current versus (dV/dt)c (typical values) (BW/CW/T1235).

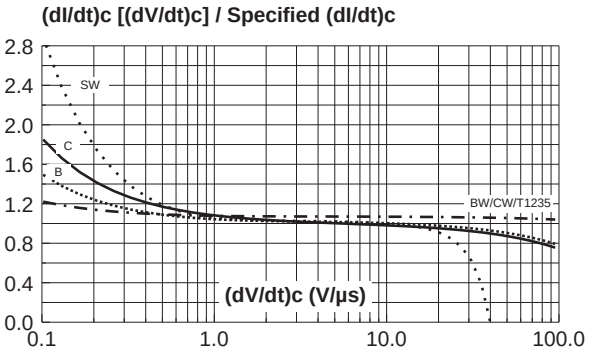


Fig. 8-2: Relative variation of critical rate of decrease of main current versus (dV/dt)c (typical values) (TW).

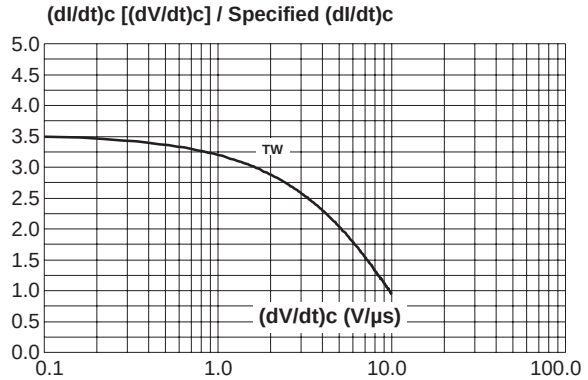


Fig. 9: Relative variation of critical rate of decrease of main current versus junction temperature.

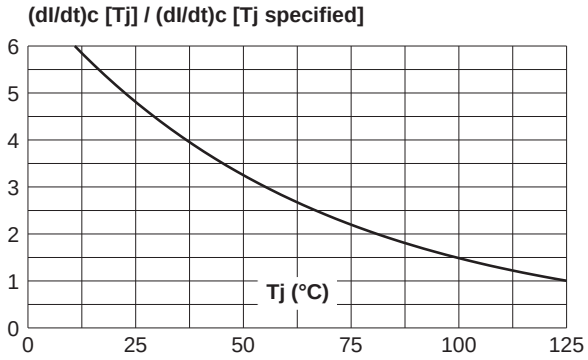
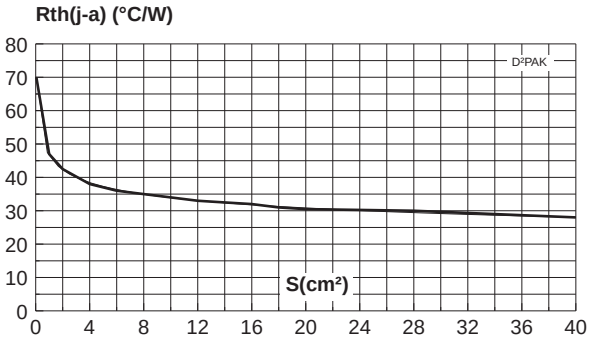
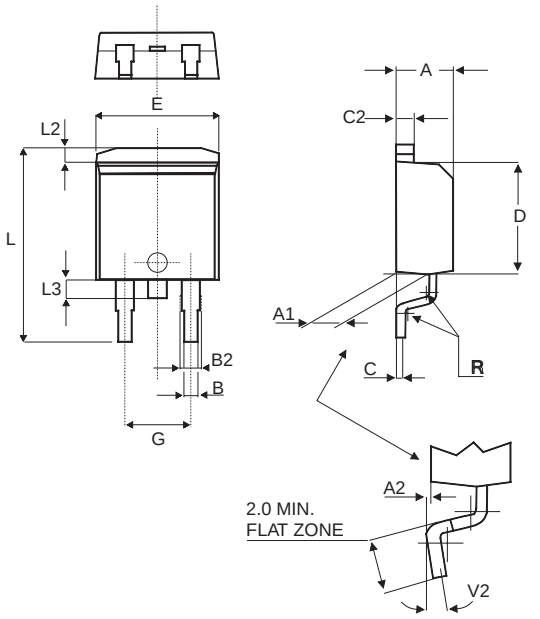


Fig. 10: D²PAK Thermal resistance junction to ambient versus copper surface under tab (printed circuit board FR4, copper thickness: 35 µm).



PACKAGE MECHANICAL DATA

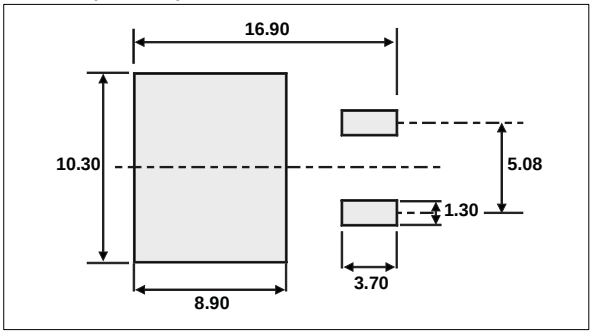
D²PAK (Plastic)



REF.	DIMENSIONS					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.30		4.60	0.169		0.181
A1	2.49		2.69	0.098		0.106
A2	0.03		0.23	0.001		0.009
B	0.70		0.93	0.027		0.037
B2	1.25	1.40		0.048	0.055	
C	0.45		0.60	0.017		0.024
C2	1.21		1.36	0.047		0.054
D	8.95		9.35	0.352		0.368
E	10.00		10.28	0.393		0.405
G	4.88		5.28	0.192		0.208
L	15.00		15.85	0.590		0.624
L2	1.27		1.40	0.050		0.055
L3	1.40		1.75	0.055		0.069
R		0.40			0.016	
V2	0°		8°	0°		8°

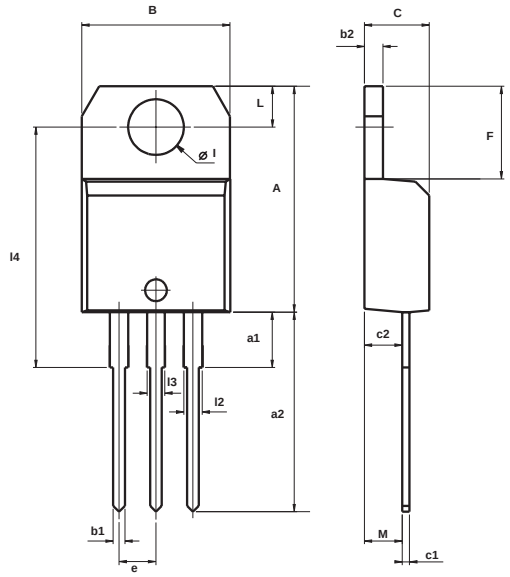
FOOTPRINT DIMENSIONS (in millimeters)

D²PAK (Plastic)



PACKAGE MECHANICAL DATA

TO-220AB / TO-220AB Ins.



REF.	DIMENSIONS					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	15.20		15.90	0.598		0.625
a1		3.75			0.147	
a2	13.00		14.00	0.511		0.551
B	10.00		10.40	0.393		0.409
b1	0.61		0.88	0.024		0.034
b2	1.23		1.32	0.048		0.051
C	4.40		4.60	0.173		0.181
c1	0.49		0.70	0.019		0.027
c2	2.40		2.72	0.094		0.107
e	2.40		2.70	0.094		0.106
F	6.20		6.60	0.244		0.259
I	3.75		3.85	0.147		0.151
l4	15.80	16.40	16.80	0.622	0.646	0.661
L	2.65		2.95	0.104		0.116
l2	1.14		1.70	0.044		0.066
l3	1.14		1.70	0.044		0.066
M		2.60			0.102	